# **EURO** QUARTZ

# X32-W CRYSTALS

**WI-FI APPLICATIONS** 

# 3.2 x 2.5 x 0.7mm SMD

#### FEATURES

- Miniature package: 3.2 x 2.5 x 0.7mm
- Gold-plated ceramic base with metal seam-welded package
- Very low ageing
- Optimized for Wi-Fi applications
- High shock and vibration resistance

# DESCRIPTION

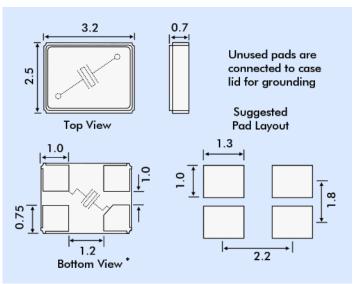
X32-W crystals are micro-miniature surface-mount mount crystals. The crystals have a gold plated ceramic base with a seam welded metal lid providing a stable crystal with very low ageing. The rugged construction ensures that this crystal has high shock and vibration resistance. The crystal has been optimized for WI-Fi applications: Bluetooth/ Bluetooth Low Energy (BLE), Bluetooth Smart, Zigbee, ISM, Wi-Fi / WLAN, LPWAN and others.

# SPECIFICATION

Standard Frequencies*:	16.0, 19.2, 20.0, 24.0, 25.0, 26.0, 27.120, 30.0, 32.0, 37.40, 38.40, 40.0, 48.0, 52.0MHz
Operating Mode:	AT-Cut Fundamental:
Calibration Tolerance at 25°C:	±10ppm
Frequency stability	
-20° to +70°C	±10ppm
-40° to +85°C	±15ppm
-40° to +105°C	±30ppm
Storage Temperature:	-50°~+105°C
Equivalent Series Resistance:	See table
Shunt Capacitance (C0):	2pF to 4pF typical, 5pF maximum
Load Capacitance (CL):	Series or from 10pF to 32pF
	(Customer specified CL)
Ageing:	<±ppm per first year at +25°C
Drive level:	100 μW maximum
Reflow Soldering:	10s maximum at 260°C twice
	or 180s at 230°C, once.
Packaging:	12mm EIA tape and reel

**OUTLINE & DIMENSIONS** 

REACH



\* Note: These parts may be supplied with the chamfered pad in different positions. However, the crystal connection is always as shown above.

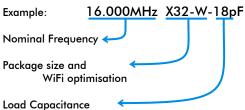
\*Note: Custom frequencies are available.

# EQUIVALENT SERIES RESISTANCE

Frequency Range MHz	ESR Ω Max.
12.0 ~ 14.9	80
15.0 ~ 19.9	50
20.0 ~ 52.0	40

# PART NUMBER GENERATION

Part numbers for X32-W crystals are generated as follows:



(Either SR for series or CL in pF)

# ENVIRONMENTAL PERFORMANCE

RoHS Status:	Compliant
Storage Temperature Range:	-55° to +105°C
Humidity:	85% RH, 85°C for 48 hours
Hermetic Seal:	Leak rate 2x10-8 ATM -cm³/s max.
Solderability:	MIL-STD-202F Method 208E
Reflow:	260°C for 10 sec (see diagram)
Vibration:	MIL-STD-202F Method 204,
	35±5 mins, 50 to 2000Hz
Shock:	MIL-STD-202F Method 213B, test Condition E, 50g 11ms.